

April 2006

FAN7602 Green Current Mode PWM Controller

Features

- Green Current Mode PWM Control
- Fixed 65kHz Operation with Frequency Modulation
- Internal High-Voltage Start-up Switch
- Burst Mode Operation
- Line Voltage Feed Forward to Limit Maximum Power
- Line Under-Voltage Protection
- Latch Protection & Internal Soft-Start (10ms) Function
- Overload Protection
- Over Voltage Protection
- Low Operation Current: Typ. 1mA
- 8-pin DIP

Applications

- Adapter
- LCD Monitor Power
- Auxiliary Power Supply

Related Application Notes

■ AN6014 - Green Current Mode PWM Controller FAN7602

Description

The FAN7602 is a green current mode PWM controller. It is specially designed for off-line adapter application, DVDP, VCR, LCD monitor application, and auxiliary power supplies.

The internal high-voltage start-up switch and the burst mode operation reduce the power loss in standby mode. Because of the internal start-up switch and the burst mode, it is possible to supply 0.5W load limiting the input power under 1W when the input line voltage is 265Vac. On no-load condition, the input power is under 0.3W.

The maximum power can be limited constantly, regardless of the line voltage change using the power limit function.

The switching frequency is internally fixed to be 65kHz and the frequency modulation technique reduces EMI.

The FAN7602 includes various protections for the system reliability and the internal soft start prevents the output voltage over-shoot at start-up.

Ordering Information

Part Number	Operating Temp. Range	Pb-Free	Package	Packing Method	Marking Code
FAN7602N	-25°C to +125°C	Yes	8-DIP	Rail	FAN7602



Typical Application Diagram

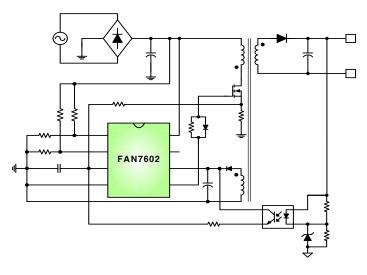


Figure 1. Typical Flyback Application

Internal Block Diagram

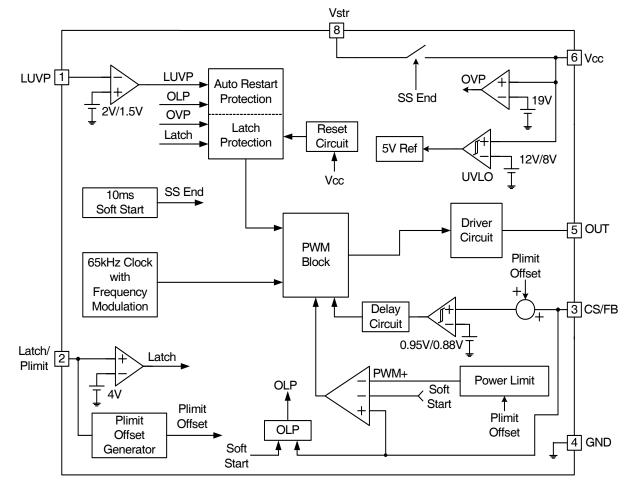


Figure 2. Functional Block Diagram of FAN7602

Pin Assignments

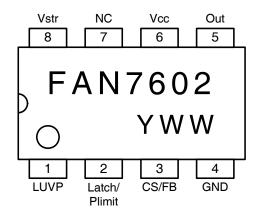


Figure 3. Pin Configuration (Top View)

Pin Definitions

Pin Number	Pin Name	Pin Function Description
1	LUVP	Line Under Voltage Protection Pin. This pin is used to protect the set when the input voltage is lower than the rated input voltage range.
2	Latch/Plimit	Latch Protection and Power Limit Pin. When the pin voltage exceeds 4V, the latch protection works and the latch protection is reset when the Vcc voltage is lower than 5V. For the power limit function, the OCP level decreases as the pin voltage increases.
3	CS/FB	Current Sense and Feedback Pin. This pin is used to sense the MOSFET current for the current mode PWM and OCP. The output voltage feedback information and the current sense information are added using external RC filter.
4	GND	Ground Pin. This pin is used for the ground potential of all the pins. For proper operation, the signal ground and the power ground should be separated.
5	OUT	Gate Drive Output Pin. This pin is an output pin to drive an external MOSFET. The peak sourcing current is 450mA and the peak sinking current is 600mA. For proper operation, the stray inductance in the gate driving path must be minimized.
6	Vcc	Supply Voltage Pin. IC operating current and MOSFET driving current are supplied using this pin.
7	NC	No Connection.
8	Vstr	Start-up Pin. This pin is used to supply IC operating current during IC start-up. After start-up, the internal JFET is turned off to reduce power loss.

Absolute Maximum Ratings

The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table defines the conditions for actual device operation.

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	20	V
I _{OH} , I _{OL}	Peak Drive Output Current	+450/-600	mA
V _{CS/FB}	CS/FB Input Voltage	-0.3 to 20	V
V _{LUVP}	LUVP Input Voltage	-0.3 to 10	V
V _{Latch}			V
Vstr	Vstr Input Voltage	600	V
Tj	Operating Junction Temperature	150	°C
Topr	Operating Temperature Range	-25 to 125	°C
Tstg	Storage Temperature Range	-55 to 150	°C
P _D	P _D Power Dissipation		W
V _{ESD_HBM}	V _{ESD_HBM} ESD Capability, Human Body Model		kV
V _{ESD_MM}	V _{ESD_MM} ESD Capability, Machine Model		V
V _{ESD_CDM}	ESD Capability, Charged Device Model	500	V

Thermal Impedance

Symbol	Parameter		Value	Unit
Rθja	Thermal Resistance, Junction to Ambient	8-DIP	100	°C/W

Note:

1. Regarding the test environment and PCB type, please refer to JESD51-2 and JESD51-10.

Electrical Characteristics

(Vcc = 14V, T_A = -25°C \sim 125°C, unless otherwise specified)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit		
START UP	SECTION		•	•	•	•		
I _{str}	Vstr Start-up Current	$V_{str} = 30V, T_A = 25^{\circ}C$	0.7	1	1.4	mA		
UNDER VO	OLTAGE LOCK OUT SECTION							
Vth(start)	Start Threshold Voltage	Vcc increasing	11	12	13	V		
Vth(stop)	Stop Threshold Voltage	Vcc decreasing	7	8	9	V		
HY(uvlo)	UVLO Hysteresis		3.6	4	4.4	V		
SUPPLY C	CURRENT SECTION							
Ist	Start-up Supply Current	T _A = 25°C	-	250	320	μΑ		
Icc	Operating Supply Current	Output no switching	-	1	1.5	mA		
SOFT STA	RT SECTION		•	•		•		
Tss	Soft Start Time ⁽¹⁾		5	10	15	ms		
PWM SEC	TION		•	•		•		
Fosc	Operating Frequency	$V_{CS/FB} = 0.2V, T_A = 25^{\circ}C$	59	65	73	kHz		
ΔF	Frequency Modulation		-	±2	-	kHz		
V _{CS/FB1}	CS/FB Threshold Voltage	T _A = 25°C	0.9	1.0	1.1	٧		
T _D	Propagation Delay to Output ⁽¹⁾		-	100	150	ns		
D _{MAX}	Maximum Duty Cycle		70	75	80	%		
D _{MIN}	Minimum Duty Cycle		-	-	0	%		
BURST MO	ODE SECTION							
V _{CS/FB2}	Burst On Threshold Voltage	T _A = 25°C	0.84	0.95	1.06	V		
V _{CS/FB3}	Burst Off Threshold Voltage	T _A = 25°C	0.77	0.88	0.99	V		
POWER LIMIT SECTION								
K _{Plimit}	Offset Gain	$V_{Latch/Plimit} = 2V, T_A = 25^{\circ}C$	0.12	0.16	0.20			
OUTPUT SECTION								
V _{OH}	Output Voltage High	$T_A = 25$ °C, Isource = 100mA	11.5	12	14	٧		
V _{OL}	Output Voltage Low	T _A = 25°C, Isink = 100mA	-	1	2.5	V		
Tr	Rising Time ⁽¹⁾	T _A = 25°C, Cl = 1nF	-	45	150	ns		
Tf	Falling Time ⁽¹⁾	T _A = 25°C, Cl = 1nF	-	35	150	ns		

Note:

1. These parameters, although guaranteed by design, are not tested in mass production.

Electrical Characteristics (Continued)

(Vcc = 14V, T_A = -25°C \sim 125°C, unless otherwise specified)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
PROTECT	ON SECTION					
V _{Latch}	Latch Voltage		3.6	4	4.4	V
T _{OLP}	Overload Protection Time (1)		20	22	24	ms
T _{OLP_ST}	Overload Protection Time at Start- up		30	37	44	ms
V _{OLP}	Overload Protection Level		-	0	0.1	V
V _{LUVPoff}	Line Under-Voltage Protection On to Off	T _A = 25°C	1.9	2	2.1	V
V _{LUVPon}	Line Under-Voltage Protection Off to On	T _A = 25°C	1.4	1.5	1.6	V
V _{OVP}	Over Voltage Protection	T _A = 25°C	18	19	20	V

Note:

1. These parameters, although guaranteed by design, are not tested in mass production.

Typical Performance Characteristics

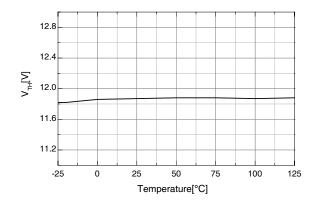


Figure 4. Start Threshold Voltage vs. Temp.

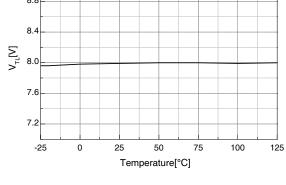


Figure 5. Stop Threshold Voltage vs. Temp.

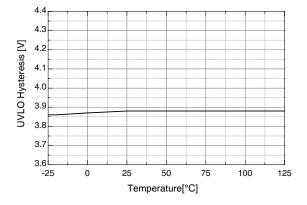


Figure 6. UVLO Hysteresis vs. Temp.

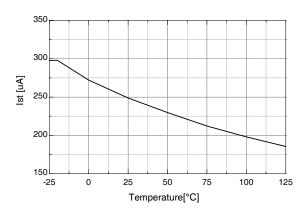


Figure 7. Start-up Supply Current vs. Temp.

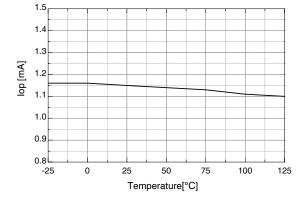


Figure 8. Operating Supply Current vs. Temp.

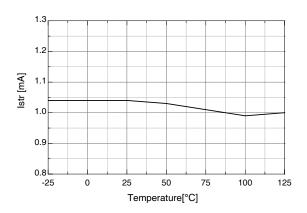


Figure 9. Vstr Star-up Current vs. Temp.

Typical Performance Characteristics (Continued)

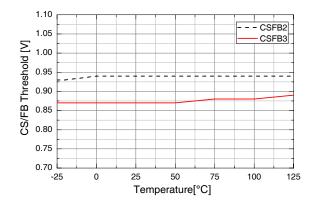


Figure 10. Burst On/Off Voltage vs. Temp.

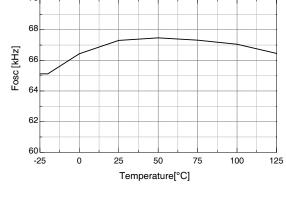


Figure 11. Operating Frequency vs. Temp.

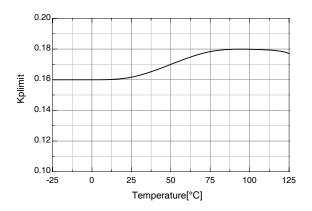


Figure 12. Offset Gain vs. Temp.

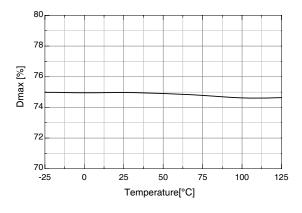


Figure 13. Maximum Duty Cycle vs. Temp.

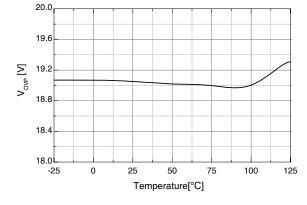


Figure 14. OVP Voltage vs. Temp.

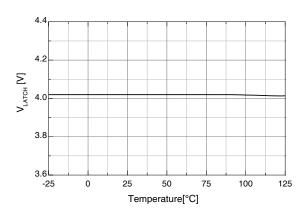
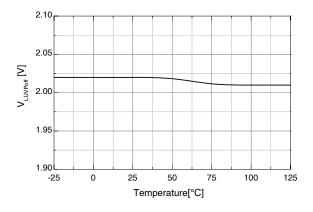


Figure 15. Latch Voltage vs. Temp.

Typical Performance Characteristics (Continued)



1.70
1.65

1.60
1.50
1.50
1.40
-25 0 25 50 75 100 125

Temperature[°C]

Figure 16. LUVP On to Off Voltage vs. Temp.

Figure 17. LUVP Off to On Voltage vs. Temp.

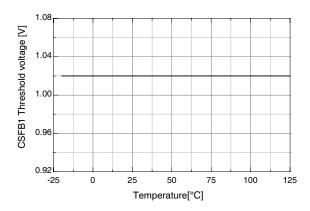


Figure 18. CS/FB Threshold Voltage vs. Temp.

Applications Information

1. Start-up Circuit and Soft Start Block

The FAN7602 contains a start-up switch to reduce the power loss of the external start-up circuit of the conventional PWM converters. The internal start-up circuit charges the Vcc capacitor with 0.9mA current source if the AC line is connected. The start-up switch is turned off 15ms after IC starts up, as shown in Fig. 19. The softstart function starts when the Vcc voltage reaches the start threshold voltage of 12V and ends when the internal soft-start voltage reaches 1V. The internal start-up circuit starts charging the Vcc capacitor again if the Vcc voltage is lowered to the minimum operating voltage, 8V. The UVLO block shuts down the output drive circuit and some blocks to reduce the IC operating current and the internal soft-start voltage drops to zero. If the Vcc voltage reaches the start threshold voltage, the IC starts switching again and the soft start block works as well.

During the soft start, pulse-width modulated (PWM) comparator compares the CS/FB pin voltage with the soft start voltage. The soft-start voltage starts from 0.5V and the soft-start ends when it reaches 1V and the soft-start time is 10ms. The start-up switch is turned off when the soft start voltage reaches 1.5V.

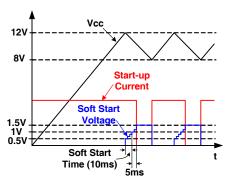


Figure 19. Start-up Current and Vcc Voltage

2. Oscillator Block

The oscillator frequency is set internally and a frequency modulation (FM) function reduces EMI. The average frequency is 65kHz and the modulation frequency is $\pm 2kHz$. The frequency varies from 63kHz to 67kHz with 16 steps. The frequency step is 250Hz and FM frequency is 125Hz, as shown in Fig. 20.

3. Current Sense and Feedback Block

The FAN7602 performs the current sensing for the current mode PWM and the output voltage feedback with only one pin, pin3. To achieve the two functions with one pin, an internal LEB (leading edge blanking) circuit to filter the current sense noise is not included because the external RC filter is necessary to add the output voltage

feedback information and the current sense information. Fig. 21 shows the current sense and feedback circuits. R_{S} is the current sense resistor to sense the switch current. The current sense information is filtered by an RC filter composed of R_{F} and C_{F} . According to the output voltage feedback information, I_{FB} charges or stops charging C_{F} to adjust the offset voltage. If I_{FB} is zero, C_{F} is discharged through R_{F} and R_{S} to lower the offset voltage.

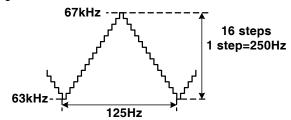


Figure 20. Frequency Modulation

Figure 22 shows typical voltage waveforms of the CS/FB pin. The current sense waveform is added to the offset voltage as shown in the figure. The CS/FB pin voltage is compared with PWM+ that is 1V - Plimit offset as shown in Fig. 22. If the CS/FB voltage meets PWM+, the output drive is shut off. As shown in Fig. 22, if the feedback offset voltage is low, the switch on time is increased. If the feedback offset voltage is high, then the switch on time is decreased. In this way, the duty cycle is controlled according to the output load condition. In general, the maximum output power increases as the input voltage increases because the current slope during switch ontime increases. To limit the output power of the converter constantly, the power limit function is included in the FAN7602. Sensing the converter input voltage through the Latch/Plimit pin, the Plimit offset voltage is subtracted from 1V. As shown in Fig. 22, the Plimit offset voltage is subtracted from 1V and the switch on-time decreases as the Plimit offset voltage increases. If the converter input voltage increases, the switch on-time decreases, controlling the output power constant. The offset voltage is proportional to the Latch/Plimit pin voltage and the gain is 0.16; if the Latch/Plimit voltage is 1V, the offset voltage is 0.16V.

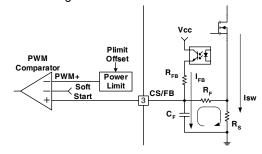


Figure 21. Current Sense and Feedback Circuits

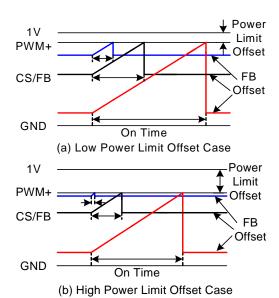


Figure 22. CS/FB Pin Voltage Waveforms

4. Burst Mode Block

The FAN7602 contains the burst mode block to reduce the power loss at a light load and no load as the FAN7601. A hysteresis comparator senses the offset voltage of the Burst+ for the burst mode as shown in Fig. 23. The Burst+ is the sum of the CS/FB voltage and Plimit offset voltage. The FAN7602 enters the burst mode when the offset voltage of the Burst+ is higher than 0.95V and exits the burst mode when the offset voltage is lower than 0.88V. The offset voltage is sensed during the switch off time.

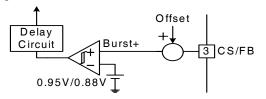


Figure 23. Burst Mode Block

5. Protection Block

The FAN7602 contains several protection functions to improve system reliability.

5.1 Overload Protection (OLP)

The FAN7602 contains the overload protection function. If the output load is higher than the rated output current, the output voltage drops and the feedback error amplifier is saturated. The offset of the CS/FB voltage representing the feedback information is almost zero. As shown in Fig. 24, the CS/FB voltage is compared with 50mV reference when the internal clock signal is high and, if the voltage is lower than 50mV, the OLP timer starts count-

ing. If the OLP condition persists for 22ms, the timer generates the OLP signal. And this protection is reset by the UVLO. The OLP block is enabled after the soft start finishes.

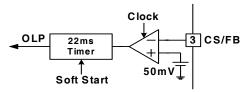


Figure 24. Overload Protection Circuit

5.2 Line Under Voltage Protection

If the input voltage of the converter is lower than the minimum operating voltage, the converter input current increases too much, causing component failure. Therefore, if the input voltage is low, the converter should be protected. In the FAN7602, the LUVP circuit senses the input voltage using the LUVP pin and, if this voltage is lower than 2V, the LUVP signal is generated. The comparator has 0.5V hysteresis. If the LUVP signal is generated, the output drive block is shut down, the output voltage feedback loop is saturated, and the OLP works if the LUVP condition persists more than 22ms.

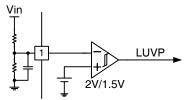


Figure 25. Line UVP Circuit

5.3 Latch Protection

The latch protection is provided to protect the system against abnormal conditions using the Latch/Plimit pin. The Latch/Plimit pin can be used for the output overvoltage protection and/or other protections. If the Latch/Plimit pin voltage is made higher than 4V by an external circuit, the IC is shut down. The latch protection is reset when the Vcc voltage is lower than 5V.

5.4 Over-Voltage Protection (OVP)

If the Vcc voltage reaches 19V, the IC shuts down and the OVP protection is reset when the Vcc voltage is lower than 5V.

6. Output Drive Block

The FAN7602 contains a single totem-pole output stage to drive a power MOSFET. The drive output is capable of up to 450mA sourcing current and 600mA sinking current with typical rise and fall time of 45ns, 35ns respectively with a 1nF load.

Typical application circuit

Application	Output power	Input voltage	Output voltage
Adapter	48W	Universal input (85~265Vac)	12V

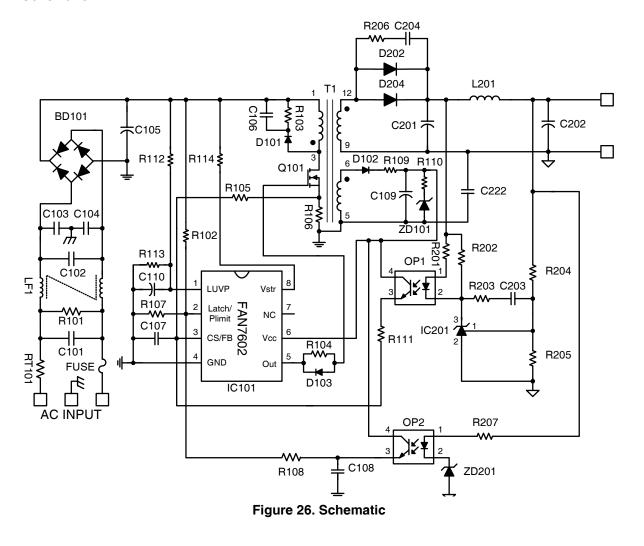
Features

- Low stand-by power (<0.3W @ 265Vac)
- Constant output power control

Key Design Notes

- All the IC-related components should be placed close to IC, especially C107 and C110.
- If R106 value is too low, there can be subharmonic oscillation.
- R109 should be designed carefully to make the Vcc voltage higher than 8V when the input voltage is 265Vac at no load
- R110 should be designed carefully to make the Vcc voltage lower than OVP level when the input voltage is 85Vac at full load.
- R103 should be designed to keep the MOSFET Vds voltage lower than maximum rating when the output is shorted.

1. Schematic



2. Inductor Schematic Diagram

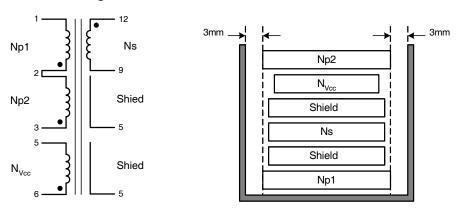


Figure 27. Inductor Schematic Diagram

3. Winding Specification

No	Pin (s→f)	Wire	Turns	Winding Method			
Np1	3 → 2	$0.3^{\varphi} \times 2$	31	Solenoid Winding			
Insulation: Polyester Tape t = 0.03mm, 2 Layers							
Shield	5	Copper Tape	0.9	Not Shorted			
Insulation: Polyester Tape t = 0.03mm, 2 Layers							
Ns	12 → 9	$0.65^{\phi} \times 3$	10	Solenoid Winding			
Insulation: P	olyester Tape t = 0.03r	nm, 2 Layers	·				
Shield	5	Copper Tape	0.9	Not Shorted			
Insulation: P	olyester Tape t = 0.03n	nm, 2 Layers	·				
N _{Vcc}	6 → 5	$0.2^{\phi} \times 1$	10	Solenoid Winding			
Insulation: Polyester Tape t = 0.03mm, 2 Layers							
Np2	2 → 1	$0.3^{\varphi} \times 2$	31	Solenoid Winding			
Outer Insulation: Polyester Tape t = 0.03mm, 2 Layers							

4. Electrical Characteristics

	Pin	Specification	Remarks
Inductance	1 - 3	607μΗ	100kHz, 1V
Inductance	1 - 3	15μΗ	9 - 12 shorted

5. Core & Bobbin

■ Core: EER2828
 ■ Bobbin: EER2828
 ■ Ae(mm²): 82.1

6. Demo Circuit Part List

Part	Value	Note	Part	Value	Note
•	Fuse			Capacitor	
FUSE	1A/250V		C101	220nF/275V	Box Capacitor
•	NTC		C102	150nF/275V	Box Capacitor
RT101 5D-9			C103, C104	102/1kV	Ceramic
•	Resistor	•	C105	150μF/400V	Electrolytic
R102, R112	10ΜΩ	1/4W	C106	103/630V	Film
R103	56kΩ	1/2W	C107	271	Ceramic
R104	150Ω	1/4W	C108	103	Ceramic
R105	1kΩ	1/4W	C109	22μF/25V	Electrolytic
R106	0.5Ω	1/2W	C110	473	Ceramic
R107	56kΩ	1/4W	C201, C202	1000μF/25V	Electrolytic
R108	10kΩ	1/4W	C203	102	Ceramic
R109	0Ω	1/4W	C204	102	Ceramic
R110	1kΩ	1/4W	C222	222/1kV	Ceramic
R111	6kΩ	1/4W		MOSFET	
R113	180kΩ	1/4W	Q101	FQPF8N60C	Fairchild
R114	50kΩ	1/4W		Diode	
R201	1.5kΩ	1/4W	D101, D102	UF4007	Fairchild
R202	1.2kΩ	1/4W	D103	1N5819	Fairchild
R203	20kΩ	1/4W	D202, D204	FYPF2010DN	Fairchild
R204	27kΩ	1/4W	ZD101, ZD201	1N4744	Fairchild
R205	7kΩ	1/4W	BD101	KBP06	Fairchild
R206	10Ω	1/2W		TNR	
R207	10kΩ	1/4W	R101	471	470V
	IC		Filter		
IC101	FAN7602	Fairchild	LF101	23mH	0.8A
IC201	KA431	Fairchild	L201	10μΗ	4.2A
OP1, OP2	H11A817B	Fairchild			

7. PCB Layout

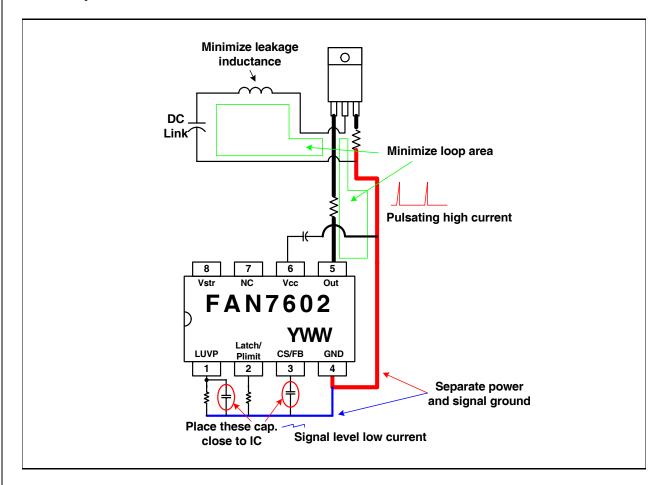


Figure 28. PCB Layout Recommendations for FAN7602

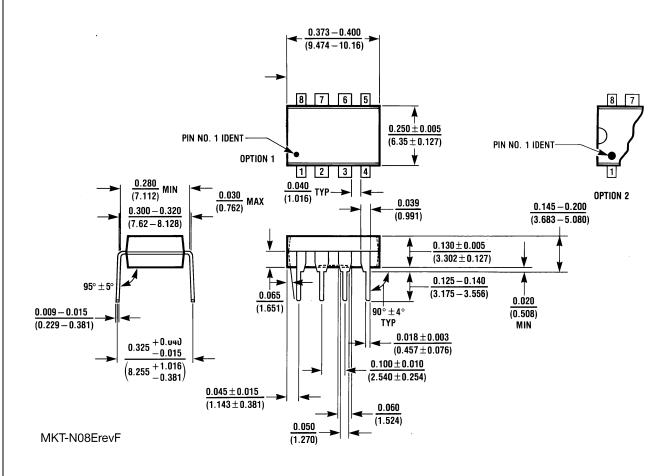
8. Performance Data

	85Vac	110Vac	220Vac	265Vac
Input Power at No Load	105.4mW	119.8mW	184.7mW	205.5mW
Input Power at 0.5W Load	739.4mW	761.4mW	825.4mW	872.2mW
OLP Point	4.42A	4.66A	4.6A	4.4A

Mechanical Dimensions

Package

Dimensions in inch (millimeters)



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Build it Now™	FRFET™	MicroFET™	QFET [®]	SuperSOT™-8
CoolFET™	GlobalOptoisolator™	MicroPak™	QS™	SyncFET™
CROSSVOLT™	GTO™	MICROWIRE™	QT Optoelectronics™	TCM™
DOME™	HiSeC™	MSX™	Quiet Series™	TinyLogic [®]
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E ² CMOS™	i-Lo™	OCX™	RapidConnect™	TruTranslation™
EnSigna™	ImpliedDisconnect™	OCXPro™	μSerDes™	UHC™
FACT™	IntelliMAX™	OPTOLOGIC [®]	ScalarPump™	UniFET™
FACT Quiet Series™		OPTOPLANAR™	SILENT SWITCHER®	UltraFET [®]
Across the board. Around the world.™		PACMAN™	SMART START™	VCX™
The Power Franchise [®]		POP™	SPM™	Wire™
Programmable Active Droop™		Power247™	Stealth™	

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PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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